

# SID

Factory: Rot am See

Article:

799

ML6

Provided:

Bierlein, Tobias

Customer:

Date:

27.11.2018



Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	B00
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	361		2	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		3	
C-RS-FR4-ML-0.20mm-105+105-TG150-HF	50201429	105	L2	4	
		200			
		105	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	268		5	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		6	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		7	
C-RS-FR4-ML-0.20mm-105+105-TG150-HF	50201429	105	L4	8	
		200			
		105	L5		
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	368		9	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		10	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	11	

Thickness after Pressing

B00: 1890 µm Tol+: 200 µm Tol-: 200 µm Dmax: 2090 µm Dmin: 1690 µm

Thickness over all

0 µm Tol+: 0 µm Tol-: 0 µm Dmax: 0 µm Dmin: 0 µm

Demand for customer

Thickness (D): 2000 µm Tol+: 200 µm Tol-: 200 µm Dmax: 2200 µm Dmin: 1800 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal: 1853 µm

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